EMD3FHA / UMD3NFHA / IMD3AFRA

NPN + PNP Complex Digital Transistors (Bias Resistor Built-in Transistors)

AEC-Q101 Qualified

Datasheet

<For DTr1(NPN)>

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	10kΩ
R_2	10kΩ

<For DTr2(PNP)>

Parameter	Value
V _{CC}	-50V
I _{C(MAX.)}	-100mA
R ₁	10kΩ
R_2	10kΩ

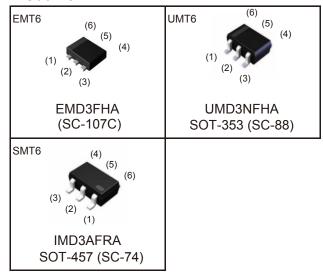
Features

- 1) Both the DTC114E chip and DTA114E chip in one package.
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- Only the on/off conditions need to be set for operation, making the circuit design easy.
- 5) Lead Free/RoHS Compliant.

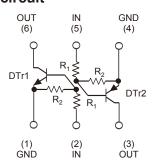
Application

Inverter circuit, Interface circuit, Driver circuit

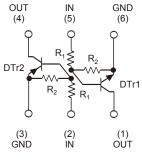
Outline



•Inner circuit



EMD3FHA / UMD3NFHA



IMD3AFRA

Packaging specifications

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Part No.	Package	Package size (mm)	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit (pcs)	Marking
EMD3FHA	EMT6	1616	T2R	180	8	8,000	D3
UMD3NFHA	UMT6	2021	TR	180	8	3,000	D3
IMD3AFRA	SMT6	2928	T108	180	8	3,000	D3

● Absolute maximum ratings (Ta = 25°C)

Parame	eter	Symbol	DTr1(NPN)	DTr2(PNP)	Unit
Supply voltage	V_{CC}	50	-50	V	
Input voltage		V_{IN}	-10 to +40	-40 to +10	V
Output current		I _o	50	–50	mA
Collector current		I _{C(MAX.)} *1	100	-100	mA
Power dissipation	EMD3FHA / UMD3NFHA	P _D *2	150 (Total) ^{*3} 300 (Total) ^{*4}		mW
rower dissipation	IMD3AFRA	r _D			mW
Junction temperature		T _j	150		°C
Range of storage temperature		T_{stg}	−55 to +150		°C

●Electrical characteristics(Ta = 25°C) <For DTr1(NPN)>

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input voltage	$V_{I(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	V
Input voltage	$V_{I(on)}$	$V_0 = 0.3V, I_0 = 10mA$	3.0	-	ı	V
Output voltage	$V_{O(on)}$	$I_{O}/I_{I} = 10mA/0.5mA$	-	0.1	0.3	V
Input current	I ₁	V _I = 5V	-	-	0.88	mA
Output current	I _{O(off)}	$V_{CC} = 50V, V_I = 0V$	-	-	0.5	μА
DC current gain	Gı	$V_O = 5V$, $I_O = 5mA$	30	-	-	-
Input resistance	R ₁	-	7	10	13	kΩ
Resistance ratio	R ₂ /R ₁	-	0.8	1	1.2	-
Transition frequency	f _T *1	$V_{CE} = 10V, I_{E} = -5mA$ f = 100MHz		250	1	MHz

●Electrical characteristics(Ta = 25°C) <For DTr2(PNP)>

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
legation alterna	$V_{I(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	1	-	-0.5	V
Input voltage	$V_{I(on)}$	$V_O = -0.3V, I_O = -10mA$	-3.0	-	-	V
Output voltage	$V_{O(on)}$	$I_{O}/I_{I} = -10\text{mA}/-0.5\text{mA}$	-	-0.1	-0.3	V
Input current	I _I	V₁ = −5V	-	-	-0.88	mA
Output current	I _{O(off)}	$V_{CC} = -50V, V_{I} = 0V$	-	-	-0.5	μΑ
DC current gain	G _I	$V_0 = -5V, I_0 = -5mA$	30	-	-	-
Input resistance	R ₁	-	7	10	13	kΩ
Resistance ratio	R ₂ /R ₁	-	0.8	1	1.2	-
Transition frequency	f _T *1	$V_{CE} = -10V, I_{E} = 5mA$ f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

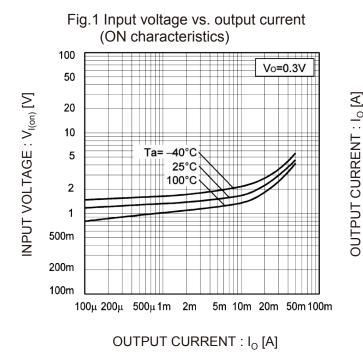


^{*2} Each terminal mounted on a reference footprint

^{*3 120}mW per element must not be exceeded.

^{*4 200}mW per element must not be exceeded.

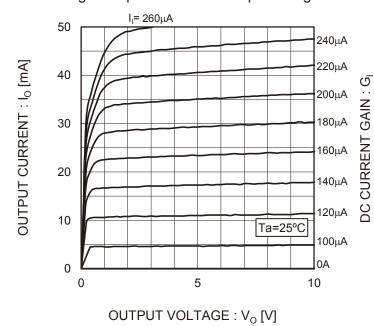
●Electrical characteristic curves (Ta = 25°C) <For DTr1(NPN)>



(OFF characteristics) 10m Vcc=5V 5m 2m Ta=100°C 1m 25°C 500μ -40°C 200μ 100μ 50μ 20μ 10μ 5μ 2μ 1μ 0 0.5 1.0 1.5 2.0 2.5 3.0 INPUT VOLTAGE : $V_{I(off)}[V]$

Fig.2 Output current vs. input voltage

Fig.3 Output current vs. output voltage



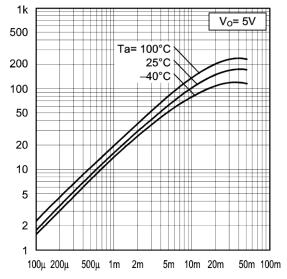
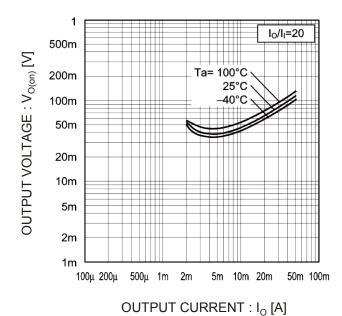


Fig.4 DC current gain vs. output current

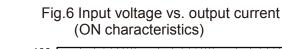
OUTPUT CURRENT : Io [A]

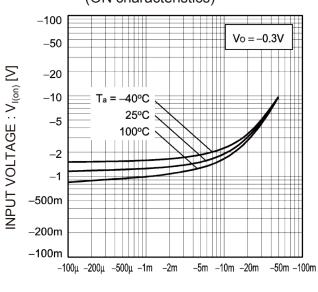
●Electrical characteristic curves (Ta = 25°C) <For DTr1(NPN)>

Fig.5 Output voltage vs. output current



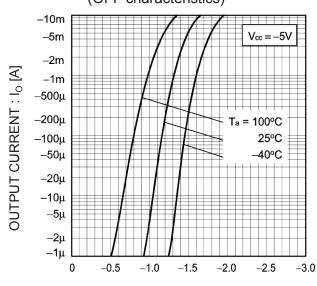
•Electrical characteristic curves (Ta = 25°C) <For DTr2(PNP)>





OUTPUT CURRENT: Io [A]

Fig.7 Output current vs. input voltage (OFF characteristics)



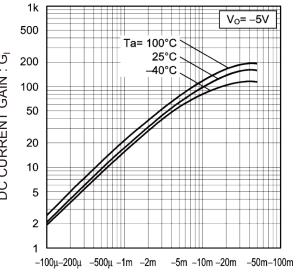
INPUT VOLTAGE: V_{I(off)}[V]

●Electrical characteristic curves (Ta = 25°C) <For DTr2(PNP)>

Fig.8 Output current vs. output voltage

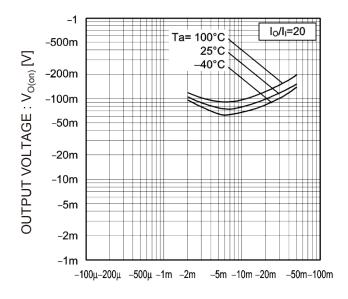
-50 Ta=25°C -300μΑ OUTPUT CURRENT: Io [mA] -40 -280μA -260μA GAIN 240μΑ -30 -220μA 180μΑ -20 -120μA -10 –100μA 0 -5 0 -10 OUTPUT VOLTAGE: Vo [V]

Fig.9 DC current gain vs. output current



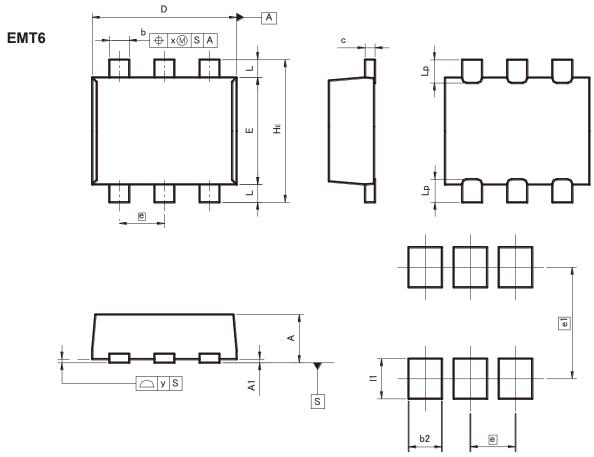
OUTPUT CURRENT : Io [A]

Fig.10 Output voltage vs. output current



OUTPUT CURRENT : Io [A]

●Dimensions (Unit : mm)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
INITO	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	-	0.35	_	0.014
х	_	0.10	_	0.004
У	-	0.10	_	0.004

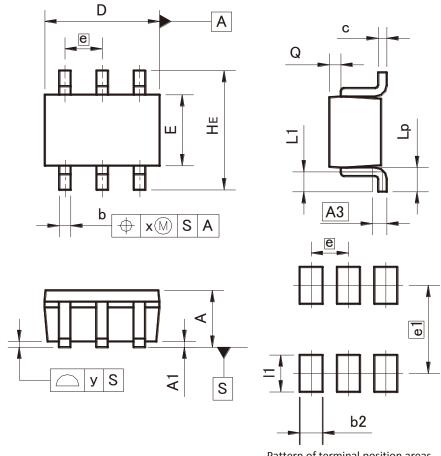
DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.37	_	0.015
e1	1.5	1.25		49
l1	_	0.45	_	0.018

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Dimension in mm / inches

●Dimensions (Unit : mm)





Pattern of terminal position areas [Not a recommended pattern of soldering pads]

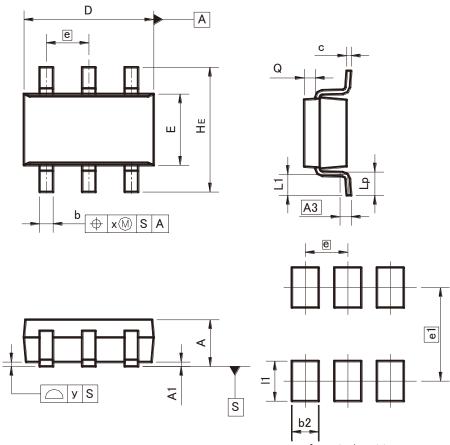
DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
Х	_	0.10	_	0.004
У	_	0.10	_	0.004

DIM MILIMETERS		ETERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
b2	_	0.40	_	0.016
e1	1.55		0.0	61
l1	_	0.65	-	0.026

Dimension in mm / inches

●Dimensions (Unit : mm)





Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	_	0.20	_	0.008
У	_	0.10	_	0.004

DIM	MILIMETE		ERS INCH	
DIM	MIN	MAX	MIN	MAX
b2		0.60	ı	0.024
e1	2.10		0.0	83
l1	_	0.90	_	0.035

Dimension in mm / inches

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